

DOCKET NO: 213480US0

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF :
SEI TSUNODA, ET AL. : EXAMINER: VIJAYAKUMAR, K.M.
SERIAL NO: 09/942,626 :
FILED: AUGUST 31, 2001 : GROUP ART UNIT: 1751
FOR: LOW DIELECTRIC CONSTANT :
MATERIAL HAVING THERMAL
RESISTANCE, INSULATION FILM
BETWEEN SEMICONDUCTOR LAYERS
USING THE SAME, AND
SEMICONDUCTOR DEVICE

AMENDMENT UNDER 37 CFR 1.312

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313

SIR:

Please amend the above-identified application pursuant to 37 CFR 1.312 as follows.

Amendments to the Claims are reflected in the listing of claims which begins on
page 2 of this paper.

Discussion of the Amendment begins on page 7 of this paper.

Remarks begin on page 8 of this paper.

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